Rev. 8-11-04 Effective March 1998

DECLARATION AND POWER OF ATTORNEY FOR U.S. PATENT APPLICATION

(X) Origin	nal () Supplemental () Substitute	(X) PCT () DESI	IGN
to my name; that I verily believe that	, I hereby declare that: my residence, post I am the original, first and sole inventor are named below) of the subject matter w	(if only one name is li	sted below) or an original, first
Title: BONDING AID FOR POL	YAMIDE RESIN AND METHOD (F BONDING WITH	I THE SAME
of which is described and claimed in () the attached specification, or () the specification in application Se (X) the specification in International applicable).	erial No, filed Application No. <u>PCT/JP2003/016238</u> , fil	, and with amendm ed_December 18, 2003	ents through, or , and as amended on(if
I hereby state that I have reviewed an by any amendment(s) referred to abo	d understand the content of the above-ide ve.	ntified specification, in	cluding the claims, as amended
I acknowledge my duty to disclose to defined in Title 37, Code of Federal l	the Patent and Trademark Office all info Regulations, §1.56.	rmation known to me t	o be material to patentability as
application(s) for patent or inventor's	er Title 35, United States Code, §119 (creatificate listed below and have also id	entified below any app	cation is for a Design) of any lication for patent or inventor's
certificate having a fining date before	that of the application on which priority	is claimed:	
COUNTRY	APPLICATION NO.	DATE OF FI	LING PRIORITY CLAIMED
	-		CLAIMED
COUNTRY	APPLICATION NO.	DATE OF FI	CLAIMED
Japan I hereby claim the benefit under Title subject matter of each of the claims of by the first paragraph of Title 35, Un	APPLICATION NO. 4068/2003 35, United States Code §120 of any United this application is not disclosed in the pited States Code §112, I acknowledge the ral Regulations, §1.56 which occurred by	DATE OF FI	CLAIMED 2003 Yes listed below and, insofar as the lication in the manner provided mation material to patentability
Japan I hereby claim the benefit under Title subject matter of each of the claims oby the first paragraph of Title 35, Un as defined in Title 37, Code of Feder	APPLICATION NO. 4068/2003 35, United States Code §120 of any United States Code §1120 of any United States Code §112, I acknowledge the ral Regulations, §1.56 which occurred be late of this application:	DATE OF FI	CLAIMED 2003 Yes listed below and, insofar as the lication in the manner provided mation material to patentability

And I hereby appoint Michael R. Davis, Reg. No. 25,134; Matthew M. Jacob, Reg. No. 25,154; Warren M. Cheek, Jr., Reg. No. 33,367; Nils Pedersen, Reg. No. 33,145; Charles R. Watts, Reg. No. 33,142; Michael S. Huppert, Reg. No. 40,268; and Jeffrey R. Filipek, Reg. No. 41,471, who together constitute the firm of WENDEROTH, LIND & PONACK, L.L.P., as well as any other attorneys and agents associated with Customer No. 000513, to prosecute this application and to transact all business in the U.S. Patent and Trademark Office connected therewith.

I hereby authorize the U.S. attorneys and agents named herein to accept and follow instructions from Naito Patent Office as to any action to be taken in the U.S. Patent and Trademark Office regarding this application without direct communication between the U.S. attorneys and myself. In the event of a change in the persons from whom instructions may be taken, the U.S. attorneys named herein will be so notified by me.

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I further declare that all statements made herein of my own knowledge are true, and that all statements on information and belief are believed to be true; and further that these statements were made with the knowledge that willful false statements and the like so made are punishable by fine or imprisonment, or both, under Section 1001 of Title 18 of the United States Code, and that such willful false statements may jeopardize the validity of the application or any patent issuing thereon.

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5th Inventor			Date				
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The above appl	ication may be more particularly ide	entified as follows:					
U.S. Applicatio	on Serial No	Filing Date	···				
Applicant Refer	pplicant Reference No		Attorney Docket No. 2005-0043A				

Title of Invention BONDING AID FOR POLYAMIDE RESIN AND METHOD OF BONDING WITH THE SAME